IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No : 2156-606A

In re Application of:

Jon Bengston

Serial No.: To be assigned

Filed: Concurrently herewith

Title: Stabilizer For Electroless Copper Plating Solution

Commissioner For Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Pursuant to Sections 609 and 707.05(b) of the MPEP and 37 CFR 1.97-1.99, a copy is herewith submitted of documents that may be pertinent to the invention as claimed in the above-identified application. The attached form PTO-1449 (1 sheet) lists these documents individually.

This Information Disclosure Statement is being filed with the filing of the application and therefore, no fee is believed to be due. In the event that a fee is due, please charge Deposit Account No.: 50-0447 to cover these fees. The citation of these documents should not be construed as a representation that a thorough search has been made, or that other, more pertinent material is not available.

Respectfully submitted,

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Serial No.: To be determined INFORMATION DISCLOSURE Docket No.: 2156-606A CITATION FORM FOR PATENT APPLICATION Applicant: Jon Bengston (FORM PTO-1449) (Substitute) Filing Date: Concurrently herewith Group: U.S. PATENTS Name Class Sub-Initials Patent Number Issue Date Filing date class 3.011.920 12/5/61 Shipley, Jr. 3.532.518 10/6/70 D'Ottavio 3,804,638 4/16/74 Jonker, et al. 4,279,948 7/21/81 Kukanskis, et al. 4,608,275 8/26/86 Kukanskis, et al. FOREIGN PATENT DOCUMENTS Date Country Translation? Initials Document Number Name Yes/No/n/a OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known) Examiner's Signature: Date Considered: Initial if reference was considered, whether or not citation is in conformance with MPEP. Mark through citation if not considered. Include a copy of this citation form with your next correspondence to the Applicant(s).